Current-Shunt Monitor, Voltage Output, Bi-Directional Zero-Drift

The NCS210, NCS211, NCS212, NCS213, NCS214, and NCS215 are voltage output current shunt monitors that can measure voltage across shunts at common-mode voltages from -0.3 V to 26 V, independent of supply voltage. Six fixed gains are available: 50 V/V, 75 V/V, 100 V/V, 200 V/V, 500 V/V, or 1000 V/V. The low offset of the zero-drift architecture enables current sensing with maximum drops across the shunt as low as 10 mV full-scale.

The devices can operate from a single +2.7 V to +26 V power supply, drawing a maximum of 100 μ A of supply current. All versions are specified over the extended operating temperature range (-40°C to +125°C). Available in SC-70 and thin UQFN space-saving packages.

Features

- Wide Common–Mode Input Range –0.3 V to 26 V
- Supply Voltage Range from 2.7 V to 26 V
- Low Offset Voltage ±60 μV Max
- Low Offset Drift (0.1 μ V/°C)
- Low Gain Error (max 1%)
- Rail-to-rail Input and Output Capability
- Low Current Consumption (typ 65 μA, 100 μA max)
- NCV Prefix for Automotive and Other Applications Requiring Unique Site Qualified and PPAP Capable
- These are Pb-free Devices

Typical Applications

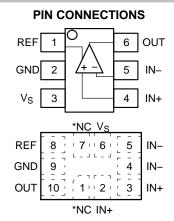
- Current Sensing (High–Side/Low–Side)
- Automotive
- Telecom
- Sensors



ON Semiconductor®

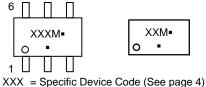
www.onsemi.com

SC70-6	UQFN10
SQ SUFFIX	MU SUFFIX
CASE 419B	CASE 488AT



*NC denotes no internal connection. These pins can be left floating or connected to any voltage between Vs and GND.

MARKING DIAGRAMS



XXX = Specific Device Code (See page 4) M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

Product	Gain	R3-R4	R1-R2
NCS213	50	20 kΩ	1 MΩ
NCS215	75	13.3 kΩ	1 MΩ
NCS214	100	10 kΩ	1 MΩ
NCS210	200	5 kΩ	1 MΩ
NCS211	500	2 kΩ	1 MΩ
NCS212	1000	1 kΩ	1 MΩ
		•	

 $V_{OUT} = (I_{LOAD} \times R_{SHUNT})GAIN + V_{REF}$

ORDERING INFORMATION

This document contains information on some products that are still under development. ON Semiconductor reserves the right to change or discontinue these products without notice.

See detailed ordering, marking and shipping information on page 4 of this data sheet.

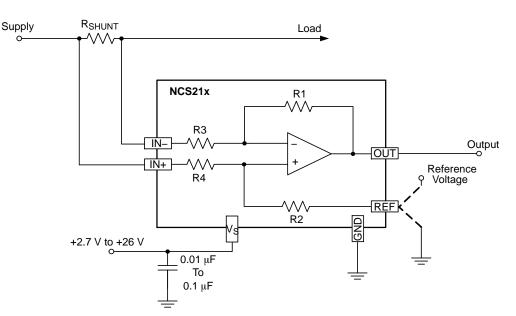


Figure 1. Application Schematic

Table 1. MAXIMUM RATINGS

	Rating	Symbol	Value	Unit	
Supply Voltage (Note 1)		NCS21x NCV21x	V _S	+26 +28	V
Analog Inputs	Differential (V _{IN+})–(V _{IN-})		V_{IN+}, V_{IN-}	-26 to +26	V
	Common–Mode (Note 2)	NCS21x NCV21x		GND-0.3 to +26 GND-0.3 to +28]
REF Input			V _{REF}	GND–0.3 to (V _s) +0.3	V
Output (Note 2)			V _{OUT}	GND-0.3 to (V _s) +0.3	V
Input Current into Any Pin (Not	e 2)			5	mA
Maximum Junction Temperatur	e		T _{J(max)}	+150	°C
Storage Temperature Range			TSTG	-65 to +150	°C
ESD Capability, Human Body	Model (Note 3)		HBM	±3000	V
ESD Capability, Machine Mode	el (Note 3)		MM	±100	V
Charged Device Model (Note 3	3)		CDM	±1000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for safe operating parameters.

2. Input voltage at any pin may exceed the voltage shown if current at that pin is limited to 5 mA.

3. This device series incorporates ESD protection and is tested by the following methods

ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)

ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115)

ESD Charged Device Model tested per AEC-Q100-011.

Latchup Current Maximum Rating: 50 mA per JEDEC standard: JESD78

Table 2. THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Characteristics, SC70 (Note 4) Thermal Resistance, Junction-to-Air (Note 5)	R_{\thetaJA}	250	°C/W

4. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for safe operating parameters.

5. Values based on copper area of 645 mm² (or 1 in²) of 1 oz copper thickness and FR4 PCB substrate.

Table 3. RECOMMENDED OPERATING RANGES

Rating	Symbol	Min	Max	Unit
Supply Voltage	V _S	2.7	26	V
Ambient Temperature	T _A	-40	125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Table 4. ELECTRICAL CHARACTERISTICS

Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}C$ to $125^{\circ}C$, guaranteed by characterization and/or design.

At $T_A = +25^{\circ}$ C, $V_{SENSE} = V_{IN+} - V_{IN-}$. NCS210, NCS213, NCS214 and NCS215: $V_S = +5$ V, $V_{IN+} = 12$ V, and $V_{REF} = V_S/2$, unless otherwise noted. NCS211 and NCS212: $V_S = +12$ V, $V_{IN+} = 12$ V, and $V_{REF} = V_S/2$, unless otherwise noted.

	Parameter Test Conditions		Symbol	Min	Тур	Max	Unit
G۵	IN						

GAIN					
NCS210		G	200		V/V
NCS211			500		
NCS212			1000		
NCS213			50		
NCS214			100		
NCS215			75		
Gain Error	$V_{SENSE} = -5 \text{ mV} \text{ to } 5 \text{ mV}$	G _e	±0.2	±1	%
Gain Error vs. Temperature	$T_A = -10^{\circ}C$ to $125^{\circ}C$		7	14	ppm/°C
Nonlinearity Error	$V_{SENSE} = -5 \text{ mV}$ to 5 mV		±0.01		%
Maximum Capacitive Load	No sustained oscillation		1		nF

VOLTAGE OFFSET

Offset Voltage (RTI Note 6)	NCS210,NCS211, NCS212, NCS214, NCS215	V _{SENSE} = 0 mV	V _{OS}	±0.55	±60	μV
	NCS213			±5	±100	μV
Offset Drift			δV/δΤ	0.1	0.6	μV/°C
	NCS213		δV/δΤ	0.5	1.5	μV/°C

INPUT

Input Bias Current		V _{SENSE} = 0 mV	I _{IB}			60	μA
Common-Mode In	nput Voltage Range		V _{CM}	-0.3		26	V
Common–Mode Rejection Ratio	NCS210, NCS211, NCS212, NCS214,	$V_S = 5 V$, $V_{IN+} = 2 V$ to +26 V, $V_{SENSE} = 0 mV$	CMRR	103	115		dB
NCS215		V _S = 3.3 V, V _{IN+} = 3 V to +26 V, V _{SENSE} = 0 mV		103	115		dB
		$V_{S} = 3.3 \text{ V}, V_{IN+} = 0 \text{ V} \text{ to } +26 \text{ V}, V_{SENSE} = 0 \text{ mV} (T_{A} = -10^{\circ}\text{C to } 85^{\circ}\text{C})$		103	120		dB
Common–Mode Rejection Ratio	NCS213	$V_S = 5 V$, $V_{IN+} = 2 V$ to +26 V, $V_{SENSE} = 0 mV$	CMRR	97	110		dB
		V _S = 3.3 V, V _{IN+} = 3 V to +26 V, V _{SENSE} = 0 mV		97	110		dB
		$V_{S} = 3.3 \text{ V}, V_{IN+} = 0 \text{ V} \text{ to } +26 \text{ V},$ $V_{SENSE} = 0 \text{ mV} (T_{A} = -10^{\circ}\text{C} \text{ to } 85^{\circ}\text{C})$		97	115		dB
OUTPUT							
		Beforeneed from CND	Max		F	50	m\/

Output Voltage Low	Referenced from GND $R_L = 10 \text{ k}\Omega$ to Ground	V _{OL}	5	50	mV
Output Voltage High	Referenced from V _S R _L = 10 k Ω to Ground	V _{OH}	0.05	0.2	V

Table 4. ELECTRICAL CHARACTERISTICS

Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}C$ to 125°C, guaranteed by characterization and/or design.

At $T_A = +25^{\circ}$ C, $V_{SENSE} = V_{IN+} - V_{IN-}$. NCS210, NCS213, NCS214 and NCS215: $V_S = +5$ V, $V_{IN+} = 12$ V, and $V_{REF} = V_S/2$, unless otherwise noted. NCS211 and NCS212: $V_S = +12$ V, $V_{IN+} = 12$ V, and $V_{REF} = V_S/2$, unless otherwise noted.

Parameter	Test Conditions	Symbol Min		Тур	Max	Unit
DYNAMIC PERFORMANCE						
Bandwidth (f _{-3dB})	C _{LOAD} = 10 pF, NCS210	BW		40		kHz
	C _{LOAD} = 10 pF, NCS211			25		
	$C_{LOAD} = 10 \text{ pF}, \text{ NCS212}$			10		
	$C_{LOAD} = 10 \text{ pF}, \text{ NCS213}$			100		
	$C_{LOAD} = 10 \text{ pF}, \text{NCS214}$			60		
	C _{LOAD} = 10 pF, NCS215			50		
Slew Rate		SR		0.4		V/µs
NOISE						
Spectral Density, 1 kHz (RTI Note 6)		e _n		35		nV/√Hz
POWER SUPPLY						
Operating Voltage Range	V _{SENSE} = 0 mV	Vs	2.7		26	V
Quiescent Current	V _{SENSE} = 0 mV	I _{DD}		65	100	μΑ
Quiescent Current over Temperature	V _{SENSE} = 0 mV				115	μΑ
Power Supply Rejection Ratio	V_{S} = +2.7 V to +26 V, V_{IN+} =18 V, V_{SENSE} = 0 mV	PSRR		±0.1	±10	μV/V

6. RTI = referenced-to-input.

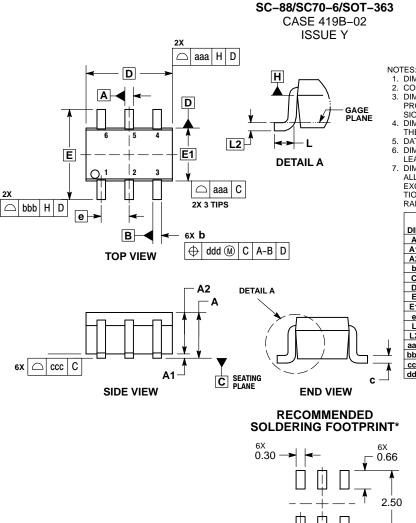
ORDERING INFORMATION

Device	Gain	Marking	Package	Shipping [†]
NCS210SQT2G	200	AAP		
NCS211SQT2G	500	AAM		
NCS212SQT2G (In Development)**	1000	AAN		
NCS213SQT2G (In Development)**	50	AAQ	1	
NCS214SQT2G (In Development)**	100	AAR		
NCS215SQT2G (In Development)**	75	AAT	SC70-6	2000 / Tana and Daal
NCV210SQT2G * (In Development)**	200	AAP	(Pb-Free)	3000 / Tape and Reel
NCV211SQT2G * (In Development)**	500	AAM		
NCV212SQT2G * (In Development)**	1000	AAN		
NCV213SQT2G * (In Development)**	50	AAQ		
NCV214SQT2G * (In Development)**	100	AAR	1	
NCV215SQT2G * (In Development)**	75	AAT	1	
NCS210MUTAG (In Development)**	200	TBD		
NCS211MUTAG (In Development)**	500	TBD	1	
NCS212MUTAG (In Development)**	1000	TBD	UQFN10	
NCS213MUTAG (In Development)**	50	TBD	(Pb-Free)	3000 / Tape and Reel
NCS214MUTAG (In Development)**	100	TBD	1	
NCS215MUTAG (In Development)**	75	TBD		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D

*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable. ** Contact local sales office for availability.

PACKAGE DIMENSIONS



- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRU-SIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H. DATUMS A AND B ARE DETERMINED AT DATUM H. DIMENSIONS DA DID & ADDI Y TO THE EI AT SECTION OF THE
- DIMENSIONS & AND C APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.
- DIMENSION 6 DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION 5 AT MAXIMUM MATERIAL CONDI-TION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

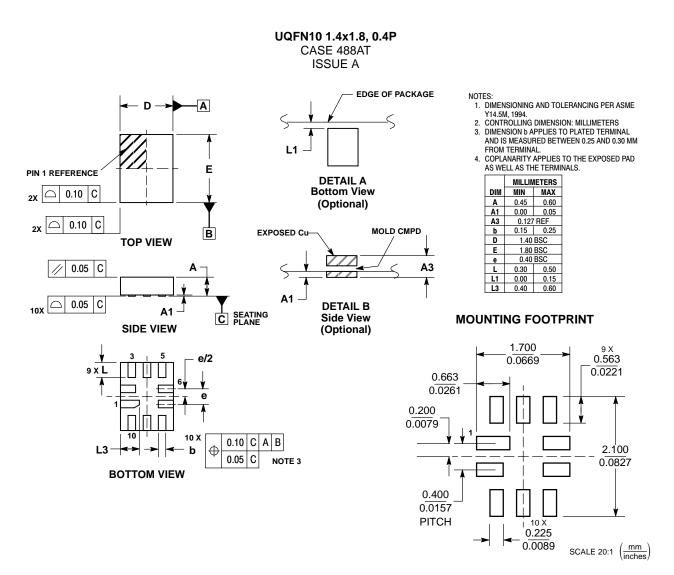
MILLIMETERS			INCHES		
MIN	NOM	MAX	MIN	NOM	MAX
		1.10			0.043
0.00		0.10	0.000		0.004
0.70	0.90	1.00	0.027	0.035	0.039
0.15	0.20	0.25	0.006	0.008	0.010
0.08	0.15	0.22	0.003	0.006	0.009
1.80	2.00	2.20	0.070	0.078	0.086
2.00	2.10	2.20	0.078	0.082	0.086
1.15	1.25	1.35	0.045	0.049	0.053
0.65 BSC			0.026 BSC		
0.26	0.36	0.46	0.010	0.014	0.018
0.15 BSC			0.006 BSC		
0.15			0.006		
0.30			0.012		
0.10			0.004		
0.10			0.004		
	MIN 0.00 0.70 0.15 0.08 1.80 2.00 1.15	MIN NOM 0.00 0.70 0.90 0.15 0.20 0.08 0.15 1.80 2.00 2.00 2.10 1.15 1.25 0.65 BS 0.36 0.15 BS 0.15 0.30 0.30	NIN NOM MAX 1.10 0.00 0.10 0.70 0.90 1.00 0.15 0.20 0.25 0.08 0.15 0.22 1.80 2.00 2.20 2.00 2.10 2.20 1.15 1.25 1.35 0.65 BSC 0.26 0.26 0.36 0.46 0.15 0.30 0.30 0.10 0.10 0.10	MIN NOM MAX MIN 1.10 0.00 0.10 0.000 0.70 0.90 1.00 0.027 0.15 0.20 0.25 0.006 0.80 1.10 0.22 0.003 1.80 2.00 2.20 0.070 2.00 2.10 2.20 0.078 1.15 1.25 1.35 0.045 0.65 BSC 0 0 0.15 0.36 0.46 0.010 0.15 0.30 0.10 0.10	MIN NOM MAX MIN NOM 1.10 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.00 0.035 0.015 0.020 0.020 0.008 0.015 0.22 0.003 0.006 1.80 2.00 2.20 0.070 0.078 0.082 1.15 1.25 1.35 0.045 0.049 0.65 BSC 0.026 BS 0.26 0.30 0.014 0.15 BSC 0.006 BS 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.014 0.024 0.014 0.014 0.014 0.014 0.014 0.014 0.014 0.014 0.014 0.014 0.014 0.014 0.014 0.014 0.014 0.014 0.01

DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

0.65 PITCH

PACKAGE DIMENSIONS



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